

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES - Wholesale and Retail.

Phase Control Disc Thyristor Type DT40-800-18

High power cycling capability / Low on-state and switching losses
Designed for traction and industrial applications

Mean on-state current	I_{TAV}		800 A					
Repetitive peak off-state voltage	V_{DRM}		1000 ÷ 1800 V					
Repetitive peak reverse voltage	V_{RRM}							
Turn-off time	t_q		160, 200, 250, 320, 400, 500 μ s					
V_{DRM}, V_{RRM}, V	1000	1100	1200	1300	1400	1500	1600	1800
Voltage code	10	11	12	13	14	15	16	18
$T_j, ^\circ C$	-60 ÷ 125							

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Mean on-state current	A	800 770	$T_c=82^\circ C$, Double side cooled $T_c=85^\circ C$, Double side cooled 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	1256	$T_c=82^\circ C$, Double side cooled 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	16.0 18.0	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; 50 Hz ($t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50 \mu$ s; $di_G/dt \geq 1$ A/ μ s
			17.0 20.0	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; 60 Hz ($t_p=8.3$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50 \mu$ s; $di_G/dt \geq 1$ A/ μ s
I^2t	Safety factor	$A^2s \cdot 10^3$	1280 1620	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; 50 Hz ($t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50 \mu$ s; $di_G/dt \geq 1$ A/ μ s
			1195 1660	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; 60 Hz ($t_p=8.3$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50 \mu$ s; $di_G/dt \geq 1$ A/ μ s
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000 ÷ 1800	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100 ÷ 1900	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; 50 Hz; single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.75 \cdot V_{DRM}$ $0.75 \cdot V_{RRM}$	$T_j=T_{jmax}$; Gate open	

TRIGGERING				
I_{FGM}	Peak forward gate current	A	8	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	4	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/ μ s	400	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; $I_{TM} = 2 I_{TAV}$; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	$^{\circ}$ C	-60÷50	
T_j	Operating junction temperature	$^{\circ}$ C	-60÷125	
MECHANICAL				
F	Mounting force	kN	14.0÷16.0	
a	Acceleration	m/s^2	50 100	Device unclamped Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	1.70	$T_j = 25 \text{ }^{\circ}\text{C}$; $I_{TM} = 2512$ A	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.00	$T_j = T_{j\max}$;	
r_T	On-state slope resistance, max	$m\Omega$	0.330	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
I_L	Latching current, max	mA	1000	$T_j = 25 \text{ }^{\circ}\text{C}$; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s	
I_H	Holding current, max	mA	300	$T_j = 25 \text{ }^{\circ}\text{C}$; $V_D = 12$ V; Gate open	
BLOCKING					
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	100	$T_j = T_{j\max}$; $V_D = V_{DRM}$; $V_R = V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	200, 320, 500, 1000	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	4.00 2.50 2.00	$T_j = T_{j\min}$ $T_j = 25 \text{ }^{\circ}\text{C}$ $T_j = T_{j\max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current
I_{GT}	Gate trigger direct current, max	mA	400 250 200	$T_j = T_{j\min}$ $T_j = 25 \text{ }^{\circ}\text{C}$ $T_j = T_{j\max}$	
V_{GD}	Gate non-trigger direct voltage, min	V	0.25	$T_j = T_{j\max}$;	
I_{GD}	Gate non-trigger direct current, min	mA	10.00	$V_D = 0.67 \cdot V_{DRM}$; Direct gate current	
SWITCHING					
t_{gd}	Delay time	μ s	2.00	$T_j = 25 \text{ }^{\circ}\text{C}$; $V_D = 0.4 \cdot V_{DRM}$; $I_{TM} = I_{TAV}$; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s	
t_q	Turn-off time ²⁾ , max	μ s	160, 200, 250, 320, 400, 500	$dv_D/dt = 50$ V/ μ s; $T_j = T_{j\max}$; $I_{TM} = I_{TAV}$; $di_R/dt = -10$ A/ μ s; $V_R = 100$ V; $V_D = 0.67 \cdot V_{DRM}$	

THERMAL

R_{thjc}	Thermal resistance, junction to case, max	°C/W	0.0320	Direct current	Double side cooled
R_{thjc-A}			0.0704		Anode side cooled
R_{thjc-K}			0.0576		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max	°C/W	0.0060	Direct current	

MECHANICAL

w	Weight, typ	g	260	
D_s	Surface creepage distance	mm (inch)	19.44 (0.765)	
D_a	Air strike distance	mm (inch)	12.10 (0.476)	

PART NUMBERING GUIDE

DT 40 800 18 7 3
 1 2 3 4 5 6

1. DT - Phase Control Disc Thyristor
2. Element Diameter
3. Mean on-state current, A
4. Voltage code
5. Critical rate of rise of on-state current non-repetitive, V/ μ s
6. Turn-off time ($dv_D/dt=50$ V/ μ s)

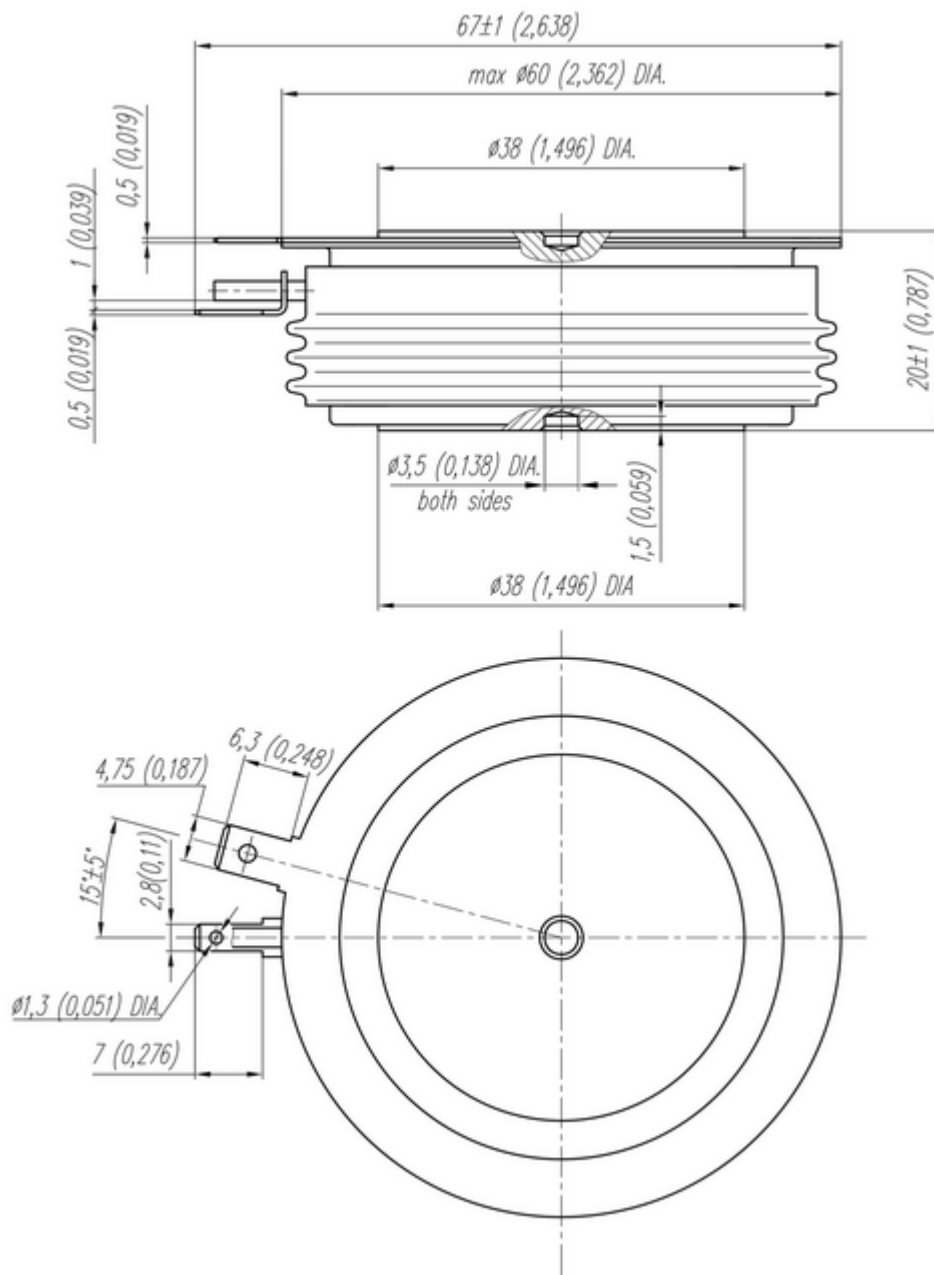
NOTES

- 1) Critical rate of rise of on-state current non-repetitive

Symbol of Group	4	5	6	7
$(dv_D/dt)_{crit}, V/\mu s$	200	320	500	1000

- 2) Turn-off time ($dv_D/dt=50$ V/ μ s)

Symbol of Group	3	0	0	0	0	0
$t_q, \mu s$	160	200	250	320	400	500



All dimensions in millimeters (inches)